# Se Incorporation in VTD-SnS by RTA and Its Influence on Performance of Thin Film Solar Cells

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**ABSTRACT:** Planner configuration thin film solar cells (TFSCs) with SnS/CdS heterojunction performed a lower short-circuit current ( $J_{SC}$ ). In this study, we have demonstrated a path to overcome deficiency in  $J_{SC}$  by the incorporation of Se in the SnS absorber. We carried out the incorporation of Se in VTD grown SnS absorber by rapid thermal annealing (RTA). The diffusion of Se is mostly governed by RTA temperature ( $T_{RTA}$ ), also it is observed that film structure changes from cube-like to plate-like structure with  $T_{RTA}$ . The maximum  $J_{SC}$  of 23.1 mA cm<sup>-2</sup> was observed for 400°C with an open-circuit voltage ( $V_{OC}$ ) of 0.140 V for the same temperature. The highest performance of 2.21% with  $J_{SC}$  of 18.6 mA cm<sup>-2</sup>,  $V_{OC}$  of 0.290 V, and fill factor (FF) of 40.9% is observed for a T<sub>RTA</sub> of 300°C. In the end, we compare the device performance of Se- incorporated SnS absorber with pristine SnS absorber material, increment in  $J_{SC}$  is approximately 80% while a loss in  $V_{OC}$  of about 20% has been observed.

Key words: Tin sulfide, Thin-film solar cells, Se grading, Efficiency, Vapor transport deposition, Rapid thermal annealing

### Nomenclature

 $E_g$ : band gap, eV  $T_{RTA}$ : RTA temperature, °C  $V_{OC}$ : open-circuit voltage, V  $J_{SC}$ : short-circuit current density, mA cm<sup>-2</sup>  $R_s$ : series resistance,  $\Omega \cdot cm^2$  $R_{sh}$ : shunt resistance,  $\Omega \cdot cm^2$ 

#### Subscript

SnS : Tin sulfide CIGS : Cu(In,Ga)Se<sub>2</sub> CdTe : Cadmium telluride XRD : X-ray diffraction FE-SEM : Field Emission Scanning Electron Microscopy TCO : Transparent Conduction Oxide FF : Fill Factor PCE : Power conversion efficiency RTA : Rapid thermal annealing VTD : Vapor transport deposition

## 1. Introduction

In the last few decades solar electricity, as a good candidate of clean and renewable energy, have achieved significant progress<sup>1</sup>). In addition to conventional c-Si (single crystal silicon) solar cells, thin-film solar cells (TFSCs) have also been established in industry<sup>2-4)</sup>. Recently, metal chalcogenide-based materials have emerged as a promising absorber for TFSCs due to toxic and rare earth elements present in established CdTe and CIGS TFSCs<sup>5-7)</sup>. The optical energy band gap  $(E_g)$  of metal chalcogenidebased materials lies between 1.1 to 1.7 eV with a high absorption coefficient of  $\geq 10^5$  cm<sup>-1</sup>, making them favorable absorber candidates for next generation TFSCs<sup>8-9)</sup>. Among these metalchalcogenide-based materials, tin sulfide (SnS) has emerged as promising absorber material for TFSCs owing to its excellent optical and electrical properties and intrinsically having p-type carrier concentration with excellent stability<sup>10-11)</sup>. SnS has scalable potential to fulfill material demand for the thin-film device industry as it contains non-toxic and earth abundant elements<sup>12-13</sup>). The electronic properties of absorber material influence the performance of TFSCs largely. The SnS thin film deposited on Mo by vapor transport deposited (VTD) has a bandgap of about 1.3 eV and solar radiation absorption power of about ( $\geq 10^5$  cm<sup>-1</sup>)

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which is most favorable for TFSCs<sup>14</sup>. However, except few cases in which power conversion efficiency (PCE) is above 4.0%, the performance of SnS based solar cells are mostly below 4.0%. More recently, Yun et al. reported a record PCE of 4.8% for SnS/TiO<sub>2</sub> based heterojunction<sup>15</sup>. Moreover, the PCE of these high performance SnS TFSCs remains far below the theoretical reported value of ~32.0%. Such lower performance of SnS-based TFSCs is mainly due to lower short-circuit current density ( $J_{SC}$ ) value, lower minority carrier lifetime, owing to higher recombination rate assisted by multi-defect states present in absorber and unfavorable conduction band offset (CBO) with n-type buffer<sup>16-17</sup>.

SnS thin films can be deposited using various deposition processes, including chemical deposition as well as physical vacuum-based deposition process<sup>18-20</sup>. Low complexity, conformal growth, low cost, and ease in handling stoichiometry of film, vacuum deposition processes have great importance<sup>21</sup>. As a versatile and cost effective method to deposit thin films, VTD has attracted much attention among other vacuum techniques<sup>14</sup>. VTD deployed commercially available high purity material as a target; thus, conformal surface properties with high purity and compact thin film were deposited with high speed of deposition<sup>18</sup>. VTD is also for commercial application in the thin-film industry<sup>17, 22</sup>.

SnS deposited by VTD demonstrate a dense and flat surface film with minimum pinholes, which help in the improvement of cell performance<sup>18)</sup>. Although from VTD a compact, dense surface morphology film was obtained, but the  $J_{SC}$  of the device remains low enough in comparison to other materials with the same range of energy bandgap<sup>21)</sup>.

Here, we demonstrate a path to enhance  $J_{SC}$  of VTD grown SnS-based TFSCs by Se incorporation in SnS absorber. Se incorporation in the SnS thin film was carried out in two steps. First SnS was deposited on Mo coated glass substrates (Mo/SLG) and after that rapid thermal annealing (RTA) was deployed to defuse Se powder in the SnS absorber. It was observed that the T<sub>RTA</sub> strongly influence the performance of device, specially  $J_{SC}$  enhanced in sufficient amount.

# 2. Experimental procedure

A one zone VTD furnace was deployed to deposit SnS absorber on aMo/SLG. Before SnS deposition, Mo/SLG substrate was sequentially cleaned by isopropyl alcohol (IPA) and deionized (DI) water for 15 min each in an ultrasonication bath and dried in nitrogen gas flow. A ceramic boat containing 0.3 g of SnS powder (5N) was loaded in the middle of heating zone of the VTD furnace.

Furthermore, clean Mo/SLG was substrate put on a quartz substrate holder placed at the one end of heating zone of the VTD furnace and maintained the approximate distance of 10 cm between source and substrate. Then, a mechanical pump was used to evacuate the chamber up to a base pressure of 5.0 mTorr. Next, a flow of Ar gas was introduced in the chamber and a 2.0 Torr controlled and stabilized pressure flow was maintained inside the chamber. After that the furnace was allowed to heat up to 600°C at a ramping rate of 30°C per min and maintained at 600°C for 30 min. After the completion of deposition process furnace was allowed to cool down to room temperature, and samples were removed, and seal packed up to further device fabrication process. The Se incorporation in the film was carried out using tube furnace RTA at different temperatures. A graphite box contains 0.1 g of Se powder uniformly around the corner and sample was placed at the center of box and placed at the center of RTA furnace. The annealing temperature varied from 300°C to 400°C and annealing time of 300 s and ramping time of 20 s in an Ar flow of 50 sccm remains fixed for all the sample. A schematic of Se-incorporation by RTA is shown in Fig. 1a.

The chemical bath deposited (CBD) CdS layer was deployed to form heterojunction with SnS deposited on Mo/SLG substrate. The proximate thickness of the CdS layer was about 50 nm<sup>23)</sup>. Finally, radio frequency sputter was used to deposit transparent conducting oxide (TCO) film with combination of intrinsic zinc oxide (i-ZnO) of about 45 nm and Al-doped zinc oxide (AZO) of about 350 nm thickness<sup>23)</sup>. Al finger electrode were deposited as front contact using DC sputter to fabricate a solar cell in the configuration of (Al/AZO/i-ZnO/CdS/Se-graded SnS/Mo/SLG). The schematic device structure is shown in Fig. 1b.

Approximate thickness and surface morphology of Seincorporation inside SnS layer was studied using field emission



Fig. 1. (a) Schematic of Se grading on the top of SnS at Mo substrate, (b) Schematic of device structure

scanning electron microscope (FE-SEM, ZEISS Gemini 500). Crystal structure and peak pattern of Se-graded SnS film deposited on different substrate was carried out using X-ray diffraction and grazing incidence angle GIXRD (XRD; PANalytical PANalytical X'Pert PRO MPD) with Cu-K<sub>a</sub> radiation of 1.5406 Å. A solar simulator (San-ei Electric XES-301S, 100 mW cm<sup>-2</sup>) and Keithley 2400 source meter were utilized to measure the current densityvoltage (*J-V*) characteristic under one sun illumination. The external quantum efficiency (EQE) of devices was carried out using IPCE solar simulator (MacScience, K3100 EQX, IPCE Solar Simulator).

# 3. Result and discussion

The FE-SEM micrograph of top view microstructure of pristine and Se graded SnS film prepared at different  $T_{RTA}$  were analyzed as shown in Fig. 2(a-d) for 300°C, 350°C, and 400°C respectively. It was observed that at  $T_{RTA}$  of 300°C, the grain size of film was lower compared to pristine film, while beyond the  $T_{RTA}$  of 300°C grain size gradually increases. This may be due to the adsorption of Se atoms in the voids present in the film. Also, the surface of the film may be covered with secondary phase crystallites<sup>24-25)</sup>.

Also, the structure of the film changes from cube-like to plate like with an increase in  $T_{RTA}$ , as evident in SEM top surface

morphology. In addition, cross-section of pristine as well as Se-graded SnS on Mo/SLG substrate for  $T_{RTA}$  300°C, 350°C, and 400°C were studied as shown in Fig. 2(e-h) using FE-SEM. The elemental mapping of the prepared Se incorporated SnS thin films was performed using Energy Dispersive X-Ray Spectroscopy (EDS) to confirm chemical composition, as shown in Fig. 2(i-l). With an increase in the  $T_{RTA}$ , the Se incorporation was found to be increased within the SnS with a decrease in the S content. From the EDS analysis, the Se/(Se+S) ratio was obtained to be 0.57, 0.74, and 0.86 for  $T_{RTA}$  of 300°C, 350°C, and 400°C, respectively. The diffusion of Se inside the film was strongly influenced by  $T_{RTA}$ , which is also evident in cross-sectional FE-SEM image. It was identified that the density of the film increases owing to reduction in voids with increase in  $T_{RTA}^{20}$ .

The structural characterization of the pristine and Se-graded SnS film was carried out using X-ray diffraction and grazing incidence angle (GI-XRD) with an incident angle of  $0.5^{\circ}$  for the film prepared at different T<sub>RTA</sub> as shown in Fig. 3(a, b). Diffraction patterns indicate SnS thin film (JCPDS; 00-039-0354) with slightly shifted peak position, and as the T<sub>RTA</sub> increases a distorted peak of SnSe (JCPDS; 00-048-1225) was observed in XRD patterns which confirms the diffusion of Se in SnS thin



Fig. 2. FE-SEM image of Se graded SnS top surface morphology (a) As deposited VTD-SnS, (b) 300°C T<sub>RTA</sub>, and (c) 350°C T<sub>RTA</sub>, and (d) 400°C T<sub>RTA</sub>, and cross-section view (e) As deposited VTD-SnS, (f) 300°C T<sub>RTA</sub>, (g) 350°C T<sub>RTA</sub>, and (h) 400°C T<sub>RTA</sub> and EDS elemental mapping of (i) As deposited SnS, and selenized SnS at (j) 300°C T<sub>RTA</sub>, (k) 350°C T<sub>RTA</sub>, and (l) 400°C T<sub>RTA</sub>



Fig. 3. (a) XRD and (b) GI-XRD image of Se incorporated SnS at different temperatures, and pristine VTD-SnS thin film

film. Some weak XRD peaks of  $SnSe_2$  were also observed. All the diffraction patterns confirm diffusion of Se inside the film. GI-XRD of as deposited VTD-SnS as well as Se incorporated samples at different  $T_{RTA}$  was carried out. As clear from Fig. 3(b) with  $T_{RTA}$  the distortion in peak position is observed. The secondary phases get intensify with  $T_{RTA}$ .

The rough estimation of the particle size was calculated from crystallite size obtained from XRD analysis. The crystallite sizes were calculated using the Scherrer formula<sup>27)</sup>.

$$D_{hkl} = \frac{K\lambda}{\beta_{hkl}\cos\theta}$$

where K is particle shape factor,  $\lambda$  is X-ray wavelength,  $\beta_{hkl}$  is full width at half maxima of obtained XRD peak, and  $\theta$  is Bragg's diffraction angle. The calculated crystallite size of SnSSe films decreased from 19.6 nm for 300°C T<sub>RTA</sub> to 17.6 nm for 400°C T<sub>RTA</sub>. During selenization, the Se molecules were diffused owing to thermal kinetics and rearranged to form larger-sized crystal grains. Further increasing the selenization temperature from 300°C to 400°C, leads to a more dense and uniform crystalline thin film from cube-like to ellipsoid growth of grains with an increase in grain size, which is advantageous for suppressing the recombination loss at the grain boundaries. In the selenization process, recrystallization of film leads to formation of secondary phases as evident in GI-XRD pattern<sup>28</sup>).

The photovoltaic characteristic of the prepared device with Se incorporated SnS absorber at  $T_{RTA}$  from 300 to 400°C and pristine samples were measured by utilizing our installed solar simulator as shown in Fig. 4(a-d) respectively. As  $T_{RTA}$  increases, the  $J_{SC}$  of the device increases leading to an increase in the



Fig. 4. Light J-V parameters of pristine and Se graded SnS (a) V<sub>OC</sub>, (b) J<sub>SC</sub>, (c) FF, and (d) PCE at different temperature

performance of the solar cell. Also, with increase in  $T_{RTA}$ ,  $V_{OC}$ and FF of the device decreases Fig. 4(a-b). Generally, it was observed that Se incorporation inside chalcogenide absorber material led to increase in  $J_{SC}$  while a loss in  $V_{OC}$  also observed at the same time<sup>29-30)</sup>. The anticipated trend of decreasing  $V_{\rm OC}$ and increasing  $J_{SC}$  with Se incorporation is observed. The Se incorporated device has a higher  $J_{SC}$  compared to the pristine SnS devices, which is explained by an improved collection at the long wavelengths<sup>31)</sup>. The improved collection could be associated with the back surface field provided by Se incorporation, as with increase in T<sub>RTA</sub> diffusion of Se also increases as observed in EDS analysis. A similar trend was observed in some previous reports<sup>32-35)</sup>. The PV parameters for champion cells are listed in Table 1. The PV properties of the device were studied by light J-V characteristic of pristine VTD-SnS and Se incorporated VTD-SnS at  $T_{RTA}$  as an absorber material, as shown in Fig. 5(a). With an increase in T<sub>RTA</sub> from 300°C to 400°C, decreasing trend in Voc from 0.290 V to 0.140 V was observed, as seen in Fig. 5(a). The device with Se incorporation at 300°C T<sub>RTA</sub> shows a slightly increased Voc than the pristine SnS device. The Dark J-V characteristic was carried out to recognize this behavior. The interface quality of the junction improves with the incorporation of Se in the VTD-SnS at 300°C T<sub>RTA</sub>, in comparison to other devices which was observed in the dark J-V characteristic Fig. 5(b). An increase in  $J_{SC}$  with the increase in  $T_{RTA}$  takes place from 18.6 to 23.0 mA  $\text{cm}^{-2}$ , which would be attributed to an increase in photo-generated current with an increase in Se content inside the film<sup>34, 36)</sup>. To understand the photogenerated current and charge collection behavior of devices EQE measurement from a wavelength of 300 nm to 1400 nm was carried out Fig. 5(c). The device with Se incorporation shows better charge collection<sup>17, 35)</sup>. A highest  $J_{SC}$  of 23.1 mA cm<sup>-2</sup> with a  $V_{OC}$  of 0.140 V, FF of 43.3% and PCE of 1.38% for the  $T_{RTA}$  of 400 °C, while highest performance of 2.21% with  $J_{SC}$  of 18.6 mA cm<sup>-2</sup>,  $V_{\rm OC}$  of 0.290 V, and FF of 40.9% was observed at a T<sub>RTA</sub> of 300°C. EQE had deployed to calculate the bandgap of pristine and Se incorporated samples at different T<sub>RTA</sub> shown in Fig.

Table 1. Photovoltaic parameters for Se graded SnS absorbervia RTA at different  $T_{RTA}$ 

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T <sub>RTA</sub>	Jsc	Voc	FF	η	Rs	<b>R</b> SH
(°C)	(mA cm <sup>-2</sup> )	(∨)	(%)	(%)	(Ω–cm²)	(Ω–cm <sup>2</sup> )
300	18.6	0.290	40.9	2.21	4.2	37.5
350	21.8	0.177	45.4	1.75	5.7	75.0
400	23.0	0.140	43.3	1.38	4.7	31.5
Ref.	13.9	0.280	49.1	1.89	4.6	150.0



Fig. 5. A comparison of (a) light *J-V* characteristic, (b) dark *J-V* characteristic, (c) EQE, and (d) bandgap calculated from EQE of Se incorporated SnS at different temperature and pristine SnS as an absorber material.

5(d). The approximate bandgap of prepared SnS is 1.323 eV, 300°C  $T_{RTA}$  is 1.316 eV, 350°C  $T_{RTA}$  is 1.279 eV, and 400°C  $T_{RTA}$  is 1.273 eV.

The increment in the  $J_{SC}$  would be attributed to the reduction in the band gap of materials, which led to increment in absorption of solar radiation with the incorporation of Se inside the SnS thin film, which may extend the absorption range to higher wavelength. The loss in  $V_{OC}$  and FF may also attribute to reduction in bandgap as well as shunt resistance of the device.

## 4. Conclusion

In conclusion, the J<sub>SC</sub> of SnS-based thin film solar cells was improved significantly by Se incorporation in SnS thin films using RTA. The diffusion of Se from the top of SnS thin film through selenization using RTA was evident in the XRD of the film. The diffusion of Se strongly depends on  $T_{RTA}$ . As  $T_{RTA}$ increases, the diffusion of Se also increases. It is observed that film structure changes from cube-like to plate-like structure with T<sub>RTA</sub>. The Se-graded SnS absorber film was used for device fabrication, which is favorable for band alignment as well as optical response. Consequently, Se-graded SnS absorber shows high  $J_{SC}$ , which leads to comparatively better performance of device. The increase in  $J_{\rm SC}$  was compensated with loss in  $V_{\rm OC}$  of the device. The maximum  $J_{SC}$  of 23.1 mA cm<sup>-2</sup> was observed for 400°C at the same time  $V_{\rm OC}$  reduces to 0.140 V. The highest performance of 2.21% with  $J_{\rm SC}$  of 18.6 mA cm<sup>-2</sup>,  $V_{\rm OC}$  of 0.290 V and FF of 40.9% is observed for an RTA temperature of 300°C.

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